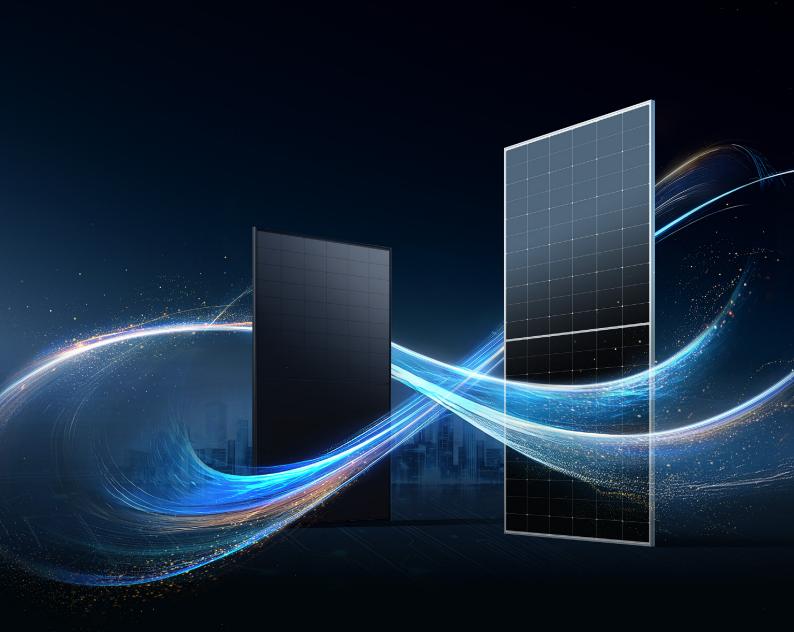


Hi-MO X10

The Pinnacle of Crystalline Silicon

Exceptional Value, Limitless Potential



Innovation Without Limits

HPBC 2.0 - Advancing Solar with 3 Breakthrough Technologies

Leading the Next Era in Cell Technology Innovation

Upgraded three-layer structure of light absorption, light-electricity conversion and current transmission

Optimised Multi-layer Anti-reflection Film: Maximizing light absorption and cell efficiency

Innovative Bipolar Hybrid Passivation: Reducing current loss

Shading Optimizer Technology: Protects against shading power loss and localized overheating

Overcoming the Boundaries of Silicon Substrate Technology

Equipped with TaiRay core wafers

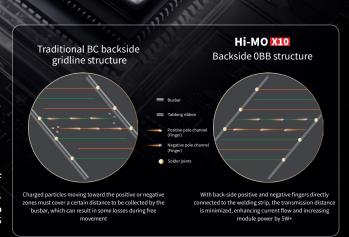
Enhancing power potential with unmatched reliability

Breaktrough in Key Materials and Processes

High-Transparency Insulation Materials and AI Assisted Manufacturing

Innovative Development Of 0BB Structures

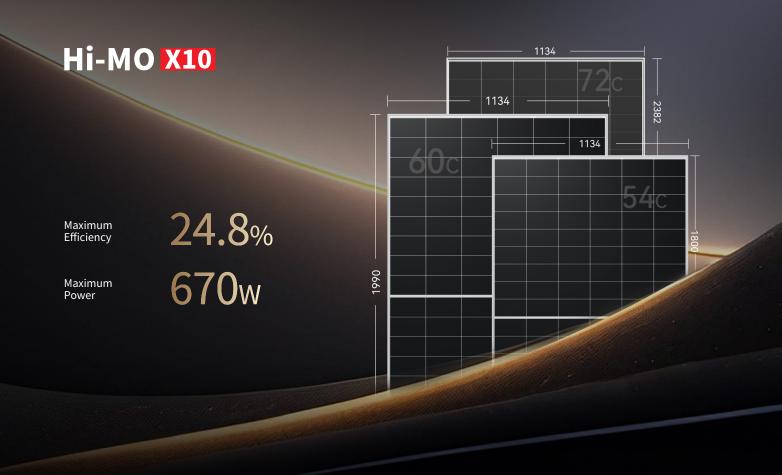
No frontal gridlines, No back busbars



AIRBCZ.O

Power Without Limits

Peak Efficiency, Mass Production Power Leading the Industry by 30W





Ambition Without Limits

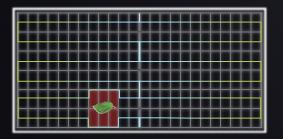
Establishing Core Superiority with Cutting-Edge Innovation

Shading Optimizer Technology

No Fear of Partial Shading | Lower Power Loss

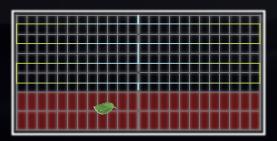
Hi-MO X10

With Self-Bypass, single-cell shading minimizes power loss for the entire string



Regular Module

Single-cell shading leads to the hard breakdown of the entire string of cells, causing a greater power loss



Preventing localized overheating

Reduced Operating Temperature | Failure Risk Drops Sharply



Hi-MO X10

The soft breakdown design significantly lowers local panel temperature



TOPCon

Shading transforms cells into current-consuming loads, increasing localized heat

Local temperature reduced by 28% + compared to a regular cell



High Efficiency



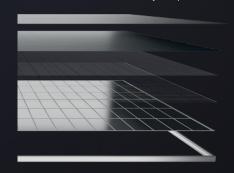
Low Temperature Coefficient

Full-Scenario Aging Suppression

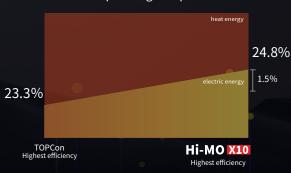
Packaging Built to Resist Aging | Increased Efficiency with Lower Temperatures

High-Reliability Lamination

- · High density lamination process · Pure silver electrode paste
- · POE encapsulation film
- · Innovative bipolar hybrid passivation



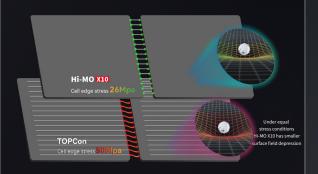
Lower Operating Temperatures



With 1.5% higher efficiency, Hi-MO X10 delivers more power, less heat, and improved aging resistance over TOPCon under the same conditions

Enhanced Resistance to Mechanical Stress

Thicker TaiRay wafer | One-line Back Contact Welding Structure





TaiRay Core

Ultra-high mechanical strength maximum rupture strength increased by 16%



Thicker Wafer

Wafer thickness is 10µm greater than other mainstream wafers leading to better reliability



Back Side Straight-Line Welding

Reduces cell edge stress and micro-cracking issues



Shading Optimizer



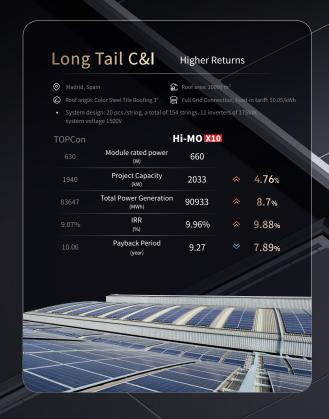
Low Failure Rate

Improved Value and Unmatched Potential



Powering Change Across Industries and Households









Unrivaled Value, Endless Possibilities

New Product for Every Scenario



Performance Leading

Peak efficiency
Resilient to high temperatures
Anti-Shading Technology



Reliability Leading

Heat and hot spot protection Advanced aging suppression Enhanced resistance to mechanical stress



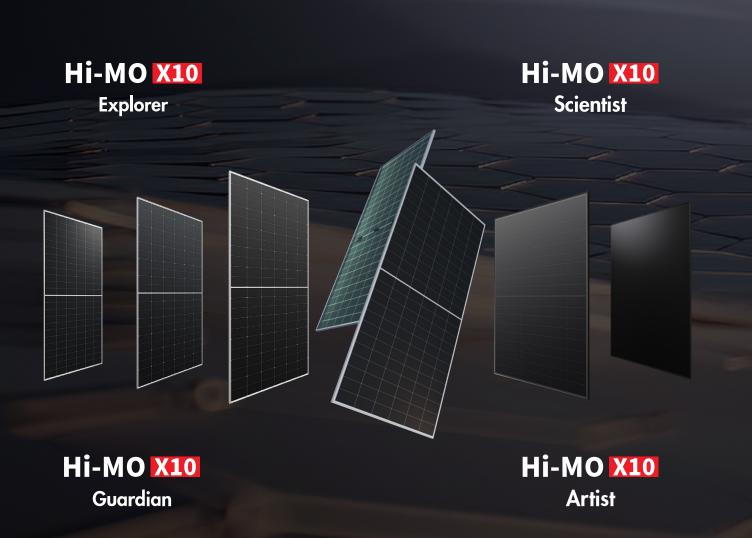
Standard Leading

Superior raw materials standards Uncompromised reliability standards



Manufacturing Leading

Cutting edge technological and sustainable manufacturing at the world's first Lighthouse Factory



LONG

www.longi.com

To Make the Best of Solar Energy To Build a Green World

Founded in 2000, LONGi Green Energy Technology Co., Ltd. (LONGi) is dedicated to becoming the world's most valuable solar technology company. Guided by its mission, 'Harnessing Solar Energy to Build a Greener World,' LONGi positions itself as the most trusted and reliable pioneer in green technology. With a commitment to innovation, LONGi develops tailored solutions for large-scale power plants, diverse industries, and households, empowering a sustainable future for all.

125.42GW

Monocrystalline Silicon Wafer Shipment (2023)

200GW

Annual Capacity Plan for the Next Three Years Wafer Annual Planed Capacity

120GW

Monocrystalline Silicon Module Capacity

170GW

Monocrystalline Silicon Wafer Capacity

67.52_{GW}

Monocrystalline Silicon Module Shipment

150gw

Annual Capacity Plan for the Next Three Years Module Annual Planed Capacity

LONGi consistently leads the industry in risk management and adaptability, prioritizing financial health and stability across its operations. With a low asset-liability ratio compared to other global PV manufacturers, LONGi stands out for its robust approach to corporate resilience and sustainable growth.

TIER 1

Tier 1 PV Module Manufacturer

Source: BNEF 1Q 2024 Global PV Market Outlook

100%

100% Bankable PV Module Brand

Source: BNEF PV Module & Inverter Bankability 2023

AAA

PV Module Tech Bankability Rating

Source : PV ModuleTech Bankability Ratings Quarterly | Q3' 24 Release